



Product Change Notification

Change Notification #: 114833 - 00
Change Title: Intel® Server System R1208SPOSHOR and Intel® 1U Spare Hot-swap Backplane F1U8X25S3HSBP, PCN 114833-00, Product Design, Product Material, Firmware Update and Replacement of components listed under RoHS exemption 7c-I
Date of Publication: August 22, 2016

Key Characteristics of the Change:

Product Design, Product Material

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material: *	Sep 16, 2016
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* Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

1. Intel is replacing components containing substances listed under EU RoHS exemption 7c-I with exemption-free components for the HSBP F1U8X25S3HSBP listed in the Products Affected table below. All new components are identical in form factor and function to the replaced ones.
2. Intel is updating the PSOC Firmware of HSBP F1U8X25S3HSBP from Rev.1.12 to Rev.1.19

Customer Impact of Change and Recommended Action:

Intel does not expect any impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Pre Change PBA	Post Change TA	Post Change PBA
R1208SPOSHOR	944477	H84662-005	H57534-212	H84662-006	H57534-212
F1U8X25S3HSBP	934888	H47019-001	G97152-352	H47019-002	G97152-371

PCN Revision History:

Date of Revision:	Revision Number:	Reason:
August 22, 2016	00	Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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